



ALPHA & OMEGA
SEMICONDUCTOR

AOC2411

30V P-Channel MOSFET

General Description

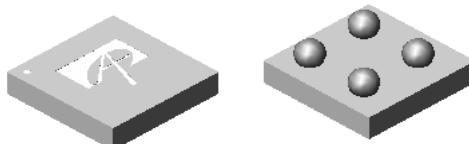
The AOC2411 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V while retaining a 12V $V_{GS(MAX)}$ rating.

Product Summary

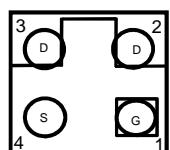
V_{DS}	-30V
I_D (at $V_{GS}=-4.5V$)	-3.4A
$R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	< 45mΩ
$R_{DS(ON)}$ (at $V_{GS}=-2.5V$)	< 60mΩ



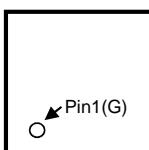
WLCSP 1.6x1.6_4



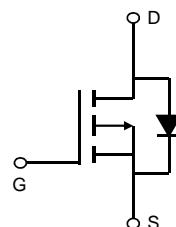
Bottom View



Top View



Equivalent Circuit



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 12	V
Source Current (DC) Note1	I_D	-3.4	A
Source Current (Pulse) Note2	I_{SM}	-52	
Power Dissipation Note1	P_D	0.8	W
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient Note1	$R_{\theta JA}$	75	90	°C/W
Maximum Junction-to-Ambient Steady-State		130	155	°C/W
Maximum Junction-to-Foot(Drain)	$R_{\theta JF}$	16	20	°C/W

Note 1. Mounted on minimum pad PCB

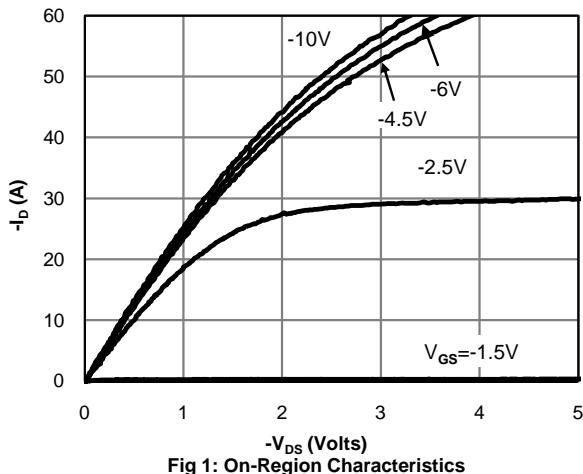
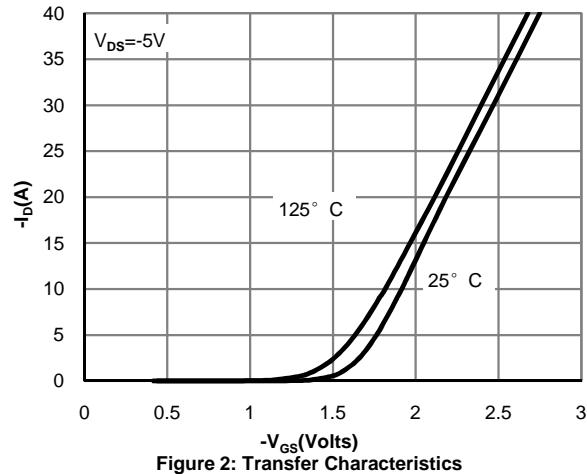
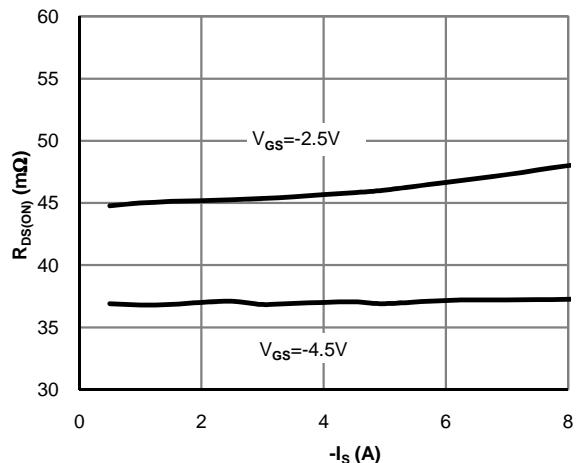
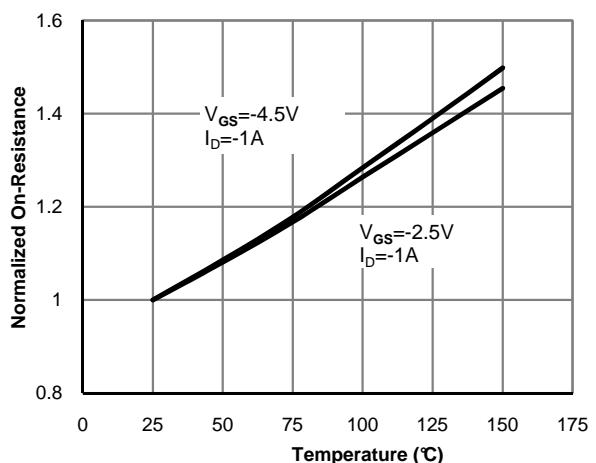
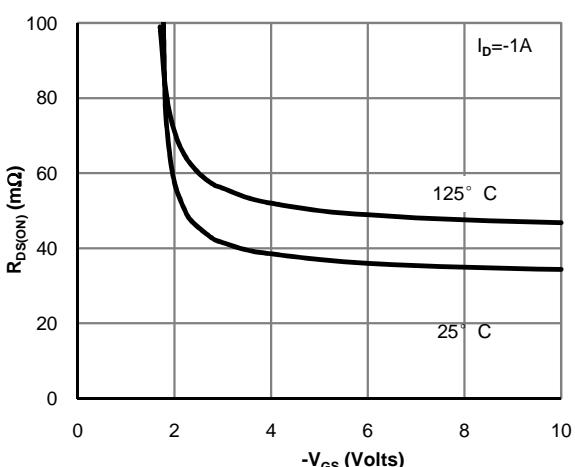
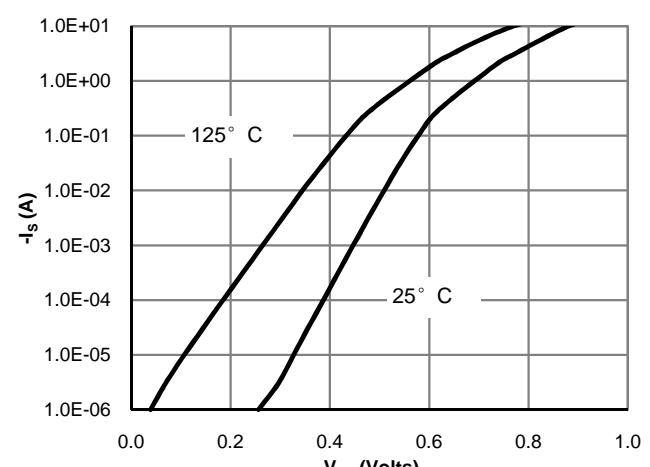
Note 2. PW <300 µs pulses, duty cycle 0.5% max

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Source-Source Breakdown Voltage	$I_D=-250\mu\text{A}, V_{GS}=0\text{V}$	-30			V
I_{DSS}	Zero Gate Voltage Source Current	$V_{DS}=-30\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			-1 -5	μA
I_{GSS}	Gate leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm12\text{V}$			±100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-0.6	-1	-1.4	V
$R_{\text{DS(ON)}}$	Static Source to Source On-Resistance	$V_{GS}=-4.5\text{V}, I_D=-1\text{A}$		37	45	$\text{m}\Omega$
		$V_{GS}=-2.5\text{V}, I_D=-1\text{A}$ $T_J=125^\circ\text{C}$		52	63	
g_{FS}	Forward Transconductance	$V_{DS}=-5\text{V}, I_D=-1\text{A}$		7.5		S
V_{FSD}	Diode Forward Voltage	$I_D=-1\text{A}, V_{GS}=0\text{V}$		-0.7	-1	V
DYNAMIC PARAMETERS Note1						
C_{iss}	Input Capacitance			1253	1630	pF
C_{oss}	Output Capacitance	$V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$		167	220	pF
C_{rss}	Reverse Transfer Capacitance			105	150	pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		16.7	34	Ω
SWITCHING PARAMETERS Note1						
Q_g	Total Gate Charge			12.5	20	nC
Q_{gs}	Gate Source Charge	$V_{GS}=-4.5\text{V}, V_{DS}=-10\text{V}, ID=-1\text{A}$		2		nC
Q_{gd}	Gate Drain Charge			3.2		nC
$t_{\text{D(on)}}$	Turn-On DelayTime			14	25	ns
t_r	Turn-On Rise Time	$V_{GS}=-4.5\text{V}, V_{DS}=-10\text{V}, R_L=10\Omega$		12	20	
$t_{\text{D(off)}}$	Turn-Off DelayTime	$ID=1\text{A}, R_{\text{GEN}}=6\Omega$		150	225	
t_f	Turn-Off Fall Time			72	110	
t_{rr}	Body Diode Reverse Recovery Time	$I_F=-1\text{A}, dI/dt=100\text{A}/\mu\text{s}$		14.5	30	ns

Note 1: Guaranteed by design

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 1: On-Region Characteristics

Figure 2: Transfer Characteristics

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature

Figure 5: On-Resistance vs. Gate-Source Voltage

Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS
